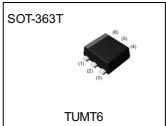


Complex Midium Power Transistor

Parameter	Tr1 and Tr2
V _{CEO}	12V
I _C	1.5A

Outline



Features

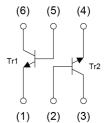
1)High current

2)Low saturation voltage

 $V_{CE(sat)}$: max.200mV at I_C =500mA/ I_B =25mA

•Inner circuit

- (1) Tr1 Emitter
- (2) Tr2 Base
- (3) Tr2 Collector
- (4) Tr2 Emitter
- (5) Tr1 Base
- (6) Tr1 Collector



Application

LOW FREQUENCY AMPLIFIER

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
US6X7	SOT-363T (TUMT6)	2021	TR	180	8	3000	X07

● **Absolute maximum ratings** (T_a = 25°C) < It is the same ratings for the Tr1 and Tr2>

Parameter	Symbol	Values	Unit
Collector-base voltage	V_{CBO}	15	V
Collector-emitter voltage		12	V
Emitter-base voltage	V _{EBO}	6	V
		1.5	Α
Collector current	I _{CP} *1	3	Α
Power dissipation		0.4	W/Total
		1.0	W/Total
Junction temperature	T _j	150	°C
Range of storage temperature	T _{stg}	-55 to +150	°C

● Electrical characteristics (T_a = 25°C) < It is the same characteristics for the Tr1 and Tr2>

Parameter	Cumbal	Conditions	Values			Lloit	
Parameter	Symbol Conditions -		Min.	Тур.	Max.	Unit	
Collector-base breakdown voltage	BV _{CBO}	I _C = 10μA	15	-	-	V	
Collector-emitter breakdown voltage	BV _{CEO} I _C = 1mA		12	-	-	V	
Emitter-base breakdown voltage	BV _{EBO}	I _E = 10μA	6	-	-	V	
Collector cut-off current	I _{CBO}	V _{CB} = 15V	-	-	100	nA	
Emitter cut-off current	I _{EBO}	V _{EB} = 6V	-	-	100	nA	
Collector-emitter saturation voltage V _{CE(sa}		I _C = 500mA, I _B = 25mA	-	85	200	mV	
DC current gain	h _{FE}	V _{CE} = 2V, I _C = 200mA	270	-	680	-	
Transition frequency	f _T	$V_{CE} = 2V, I_{E} = -200 \text{mA},$ f = 100MHz	-	400	-	MHz	
Output capacitance C_{ob} $V_{CB} = 10V, I_E = f = 1MHz$		V _{CB} = 10V, I _E = 0A, f = 1MHz	-	12	-	pF	

^{*1} Pw=1ms Single pulse

^{*2} Each terminal mounted on a reference land.

^{*3} Mounted on a ceramic board.(25×25×0.8mm)

^{*4 0.7}W per element must not be exceeded.

● Electrical characteristic curves (T_a = 25°C)

<For Tr1 and Tr2 in common>

Fig.1 Grounded emitter propagation characteristics

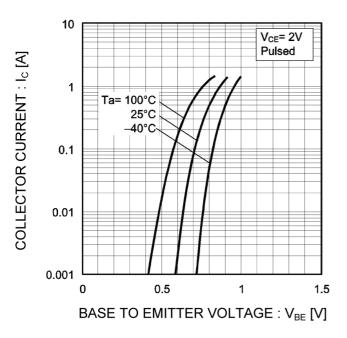
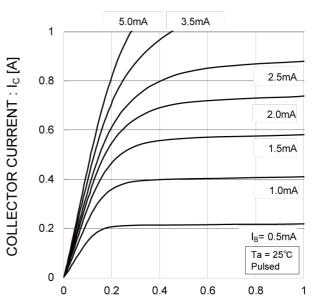


Fig.2 Typical output characteristics



COLLECTOR TO EMITTER VOLTAGE: VCE [V]

Fig.3 DC current gain vs. collector current (I)

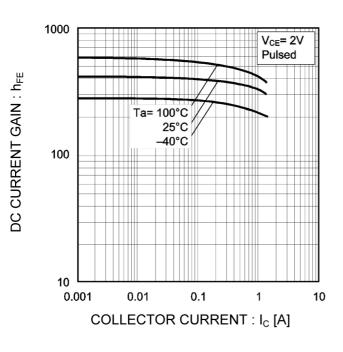
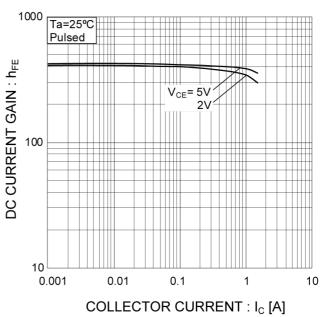


Fig.4 DC current gain vs. collector current (II)



● Electrical characteristic curves (T_a = 25°C)

<For Tr1 and Tr2 in common>

Fig.5 Collector-emitter saturation voltage vs. collector current (I)

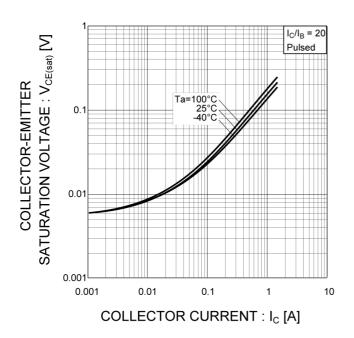


Fig.6 Collector-emitter saturation voltage vs. collector current (II)

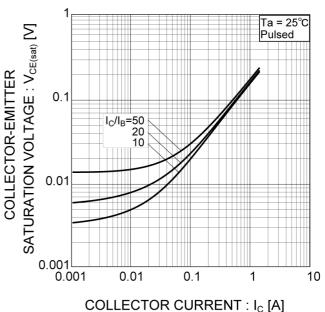


Fig.7 Base-emitter saturation voltage vs. collector current

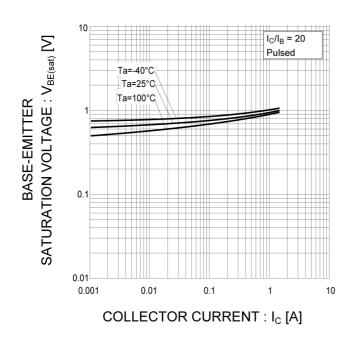
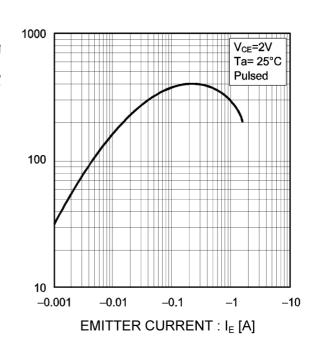


Fig.8 Gain bandwidth product vs. emitter current



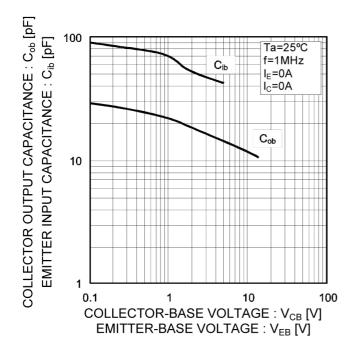
TRANSITION FREQUENCY : fr [MHz]

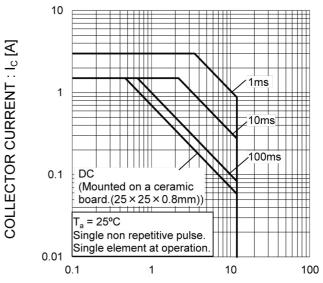
● Electrical characteristic curves (T_a =25°C)

<For Tr1 and Tr2 in common>

Fig.9 Collector output capacitance vs. collector-base voltage Emitter input capacitance vs. emitter-base voltage

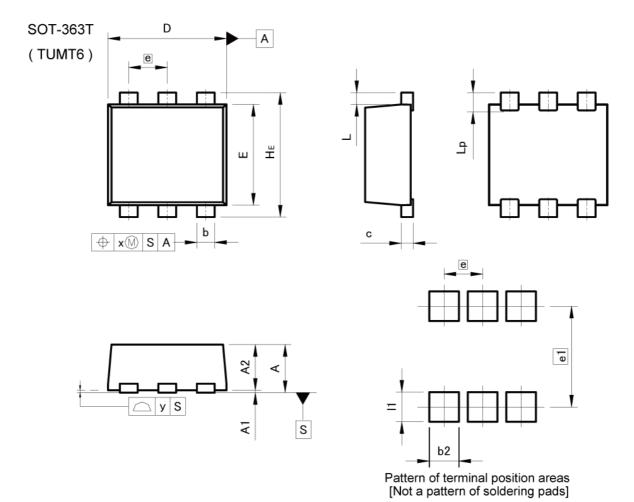
Fig.10 Safe Operating Area





COLLECTOR TO EMITTER VOLTAGE: V_{CE} [V]

Dimensions



DIM	MILIM	ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	_	0.85	-	0.033	
A1	0.00	0.05	0.000	0.002	
A2	0.72	0.82	0.028	0.032	
b	0.25	0.40	0.010	0.016	
С	0.12	0.22	0.005	0.009	
D	1.90	2.10	0.075	0.083	
E	1.60	1.80	0.063	0.071	
е	0.	65	0.0	26	
HE	2.00	2.20	0.079	0.087	
L	0.5	20	0.0	08	
Lp	-	0.40	_	0.016	
х	_	0.10	L	0.004	
у	-	0.10	-	0.004	

	NATI TNA	ETERO	INOUEC		
DIM	MILIMETERS		INCHES		
DIW	MIN MAX		MIN	MAX	
b2		- 0.50 -		0.020	
e1	1.70		0.067		
11	- 0.50		_	0.020	

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the Specific Applications

1 /	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1		
JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSIII	CLASS II b	CL ACCTI
CLASSIV	CLASSIII	CLASSⅢ	CLASSⅢ

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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
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- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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